CRMKTL0304A

N-Channel 30V, 2.8mΩ Typ. Power MOSFET

Description

Features

• 30V, 110A

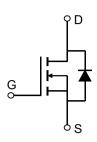
$$R_{DS(ON)}$$
 Typ = 2.8m Ω @ V_{GS} = 10 V

 $R_{DS(ON)}$ Typ = 4.1m Ω @ V_{GS} = 4.5V

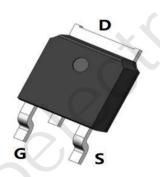
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

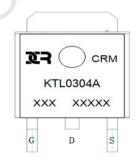
Application

- Load Switch
- PWM Application
- Power Management









Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTL0304A	CRMKTL0304A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Compart	T _C = 25°C	110	Α
l _D	Continuous Drain Current	T _C = 100°C	70	Α
I _{DM}	Pulsed Drain Current (1)		440	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		156	mJ
P_{D}	Power Dissipation	T _C = 25°C	78	W
$R_{ hetaJC}$	Thermal Resistance, Junction to Case		1.6	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Char	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				C	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.6	2.2	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_{D} = 20A$	-	2.8	3.6	mΩ
		$V_{GS} = 4.5V, I_{D} = 10A$	-	4.1	5.4	mΩ
Dynamic	Characteristics				¥	
C_{iss}	Input Capacitance			3025	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X -\	353	-	pF
C_{rss}	Reverse Transfer Capacitance			273	-	pF
Q_g	Total Gate Charge	V 04 40V	<u></u>	58	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_{D} = 30A$	-	12	-	nC
$Q_{\rm gd}$	Gate Drain("Miller") Charge	V _{DS} 10V, I _D 00/V	-	13	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime		-	11	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	29	-	ns
$\mathbf{t}_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 30A$, $R_{GEN} = 3\Omega$	-	47	-	ns
t _f	Turn-Off Fall Time		-	18	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	110	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	440	Α
$V_{\mathtt{SD}}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 30A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I _F = 30A, di/dt = 100A/us	-	16	-	ns
Qrr	Body Diode Reverse Recovery Charge	1 _F - 30A, ul/ul - 100A/us	-	7	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25C, V_{DD} =15V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =25A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

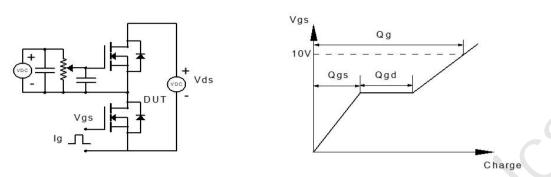


Figure 1: Gate Charge Test Circuit & Waveform

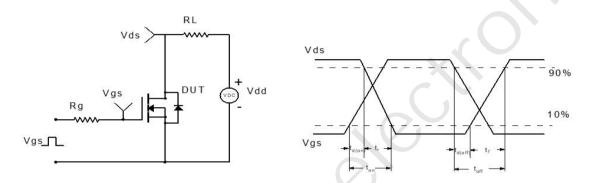


Figure 2: Resistive Switching Test Circuit & Waveform

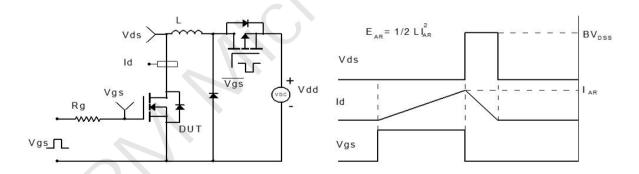


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

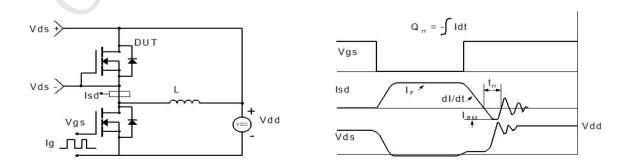
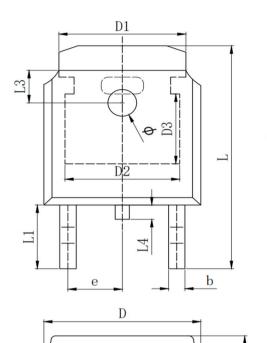


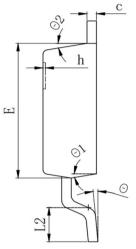
Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(TO-252-3L)





SYMBOL	MILLIMETER				
SIMDUL	MIN	MAX			
A	2. 200	2.300	2.400		
A1	0.000		0.127		
b	0.640	0.690	0.740		
c(电镀后)	0.460	0. 520	0.580		
D	6. 500	6.600	6.700		
D1	5.334 REF				
D2	4. 826 REF				
D3	3. 166 REF				
E	6.000	6. 100	6.200		
е	2.286 TYP				
h	0.000	0.100	0.200		
L	9. 900	10.100	10.300		
L1	2.888 REF				
L2	1. 400	1.550	1.700		
L3	1. 600 REF				
L4	0.600	0.800	1.000		
ф	1. 100	1.200	1.300		
θ	0°		8°		
θ 1	9° TYP				
02	9° TYP				

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